Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

# SSM3J15F

High Speed Switching Applications Analog Switch Applications

Small package

• Low ON resistance :  $R_{on} = 12 \Omega \text{ (max) (@V_{GS} = -4 V)}$ 

:  $R_{on} = 32 \Omega \text{ (max) } (@V_{GS} = -2.5 \text{ V})$ 

# Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DS}$	-30	V	
Gate-Source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC	ID	-100	mA	
	Pulse	I <sub>DP</sub>	-200		
Drain power dissipation (Ta = 25°C)		PD	200	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling

Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

1.Gate
2.Source
3.Drain

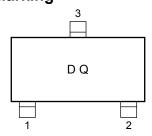
JEDEC TO-236MOD

JEITA SC-59

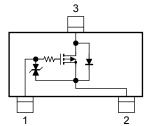
TOSHIBA 2-3F1F

Weight: 0.012g(typ.)

#### Marking



# **Equivalent Circuit (top view)**



#### **Handling Precaution**

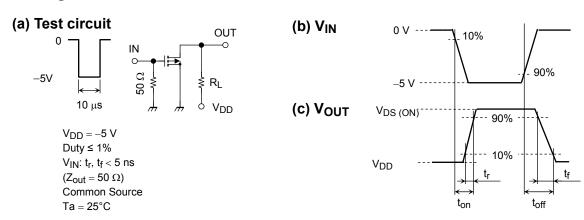
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Start of commercial production 2002-03

## **Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT	
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	_	_	±1	μА	
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -0.1 \text{ mA}, V_{GS} = 0$	-30	_	_	V	
Drain cut-off current		I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0$	_		-1	μΑ	
Gate threshold voltage		$V_{th}$	$V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$	-1.1		-1.7	>	
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = -3 \text{ V}, I_D = -10 \text{ mA}$	20		_	mS	
Drain-Source ON resistance		R <sub>DS (ON)</sub>	$I_D = -10 \text{ mA}, V_{GS} = -4 \text{ V}$	_	8	12	Ω	
			$I_D = -1 \text{ mA}, V_{GS} = -2.5 \text{ V}$	_	14	32		
Input capacitance		C <sub>iss</sub>		_	9.1	_	pF	
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	3.5	_	pF	
Output capacitance		C <sub>oss</sub>		_	8.6	_	pF	
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -5 \text{ V}, I_D = -10 \text{ mA},$ $V_{GS} = 0 \text{ to } -5 \text{ V}$	_	65	_	ns	
	Turn-off time	t <sub>off</sub>		_	175	_		

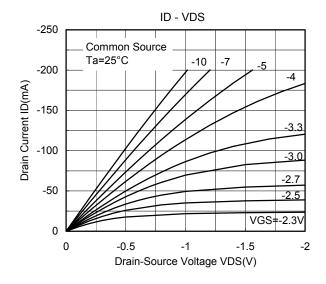
### **Switching Time Test Circuit**

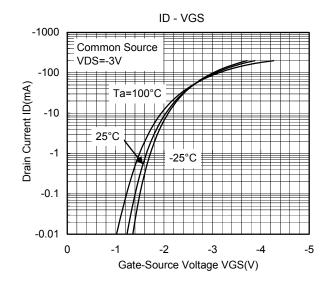


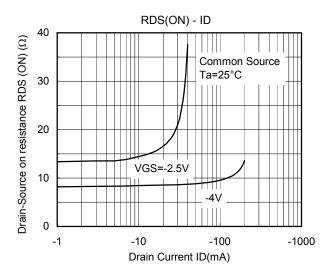
#### **Precaution**

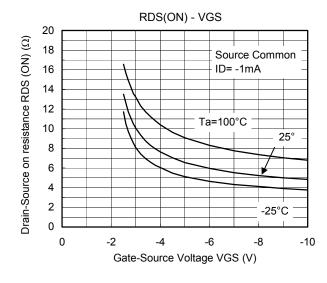
 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D$  =  $-100~\mu A$  for this product. For normal switching operation,  $V_{GS~(on)}$  requires higher voltage than  $V_{th}$  and  $V_{GS~(off)}$  requires lower voltage than  $V_{th}$ . (Relationship can be established as follows:  $V_{GS~(off)} < V_{th} < V_{GS~(on)}$ )

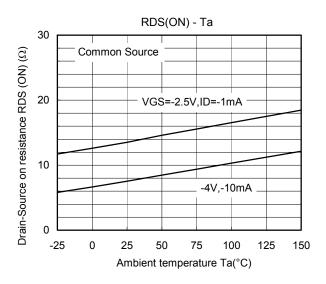
Please take this into consideration for using the device.

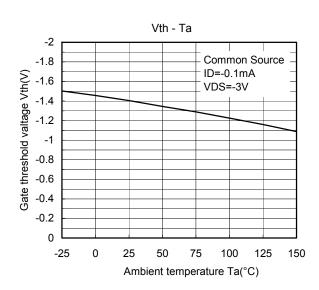


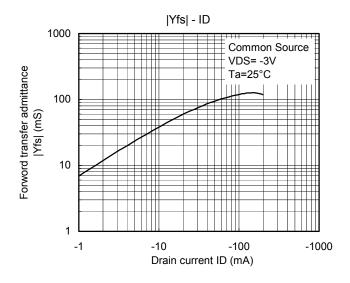


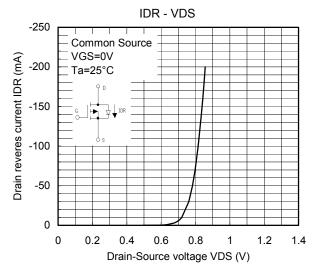


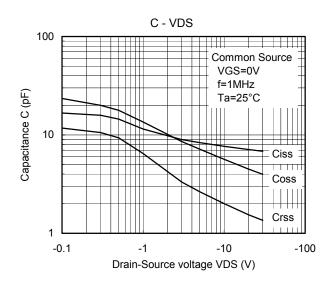


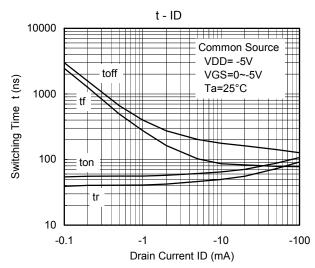


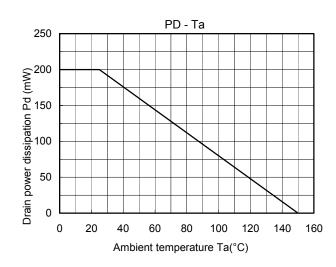












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